

Quad Buffer with 3-STATE Outputs 74VHC125

General Description

The VHC125 contains four independent non-inverting buffers with 3–STATE outputs. It is an advanced high–speed CMOS device fabricated with silicon gate CMOS technology and achieves the high–speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

An input protection circuit insures that 0 V to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High Speed: $t_{PD} = 3.8 \text{ ns}$ (Typ.) at $V_{CC} = 5 \text{ V}$
- Low Power Dissipation: $I_{CC} = 4 \mu A$ (Max.) at $T_A = 25^{\circ}C$
- High Noise Immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (Min.)
- Power Down Protection is Provided on All Inputs
- Low Noise: V_{OLP} = 0.8 V (Max.)
- Pin and Function Compatible with 74HC125
- Pb-Free, Halogen Free/BFR Free and RoHS Compliant

Logic Symbol

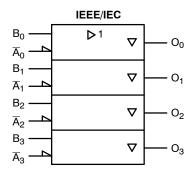


Figure 1. Logic Symbol

TRUTH TABLE

Inp	uts	Output
Ā _n	B _n	O _n
L	L	L
L	Н	Н
Н	Х	Z

H = HIGH Voltage Level

L = LOW Voltage Level

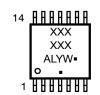
Z = HIGH Impedance

X = Immaterial



TSSOP-14 WB CASE 948G

MARKING DIAGRAM

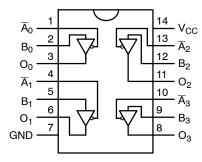


XXXXX = Specific Device Code A = Assembly Location

L = Wafer Lot Y = Year W = Work Week • Pb-Free Package

(Note: Microdot may be in either location)

CONNECTION DIAGRAM



PIN DESCRIPTION

Pin Names	Description
\overline{A}_n , B_n	Inputs
O _n	Outputs

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

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MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{CC}	DC Supply Voltage	-0.5 to +6.5	V	
V _{IN}	DC Input Voltage	-0.5 to +6.5	V	
V _{OUT}	DC Output Voltage	-0.5 to V _{CC} + 0.5	V	
I _{IN}	DC Input Current, Per Pin	±20	mA	
I _{OUT}	DC Output Current, Per Pin	±25	mA	
Icc	DC Supply Current, V _{CC} and GND Pins	±50		
I _{IK}	Input Clamp Current	-20	mA	
lok	Output Clamp Current	±20	mA	
T _{STG}	Storage Temperature Range	-65 to +150	°C	
TL	Lead Temperature, 1 mm from Case for 10 s	260	°C	
TJ	Junction Temperature Under Bias	+150	°C	
$\theta_{\sf JA}$	Thermal Resistance (Note 1)	150	°C/W	
P_{D}	Power Dissipation in Still Air at 25°C	833	mW	
V _{ESD}	ESD Withstand Voltage (Note 2) Human Body Model Charged Device Model	>2000 N/A	V	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage	2.0	5.5	V
V _{IN}	DC Input Voltage (Note 3)	0	5.5	V
V _{OUT}	DC Output Voltage (Note 3)	0	V _{CC}	V
T _A	Operating Temperature	-40	+85	°C
t _r , t _f	Input Rise or Fall Rate V _{CC} = 3.0 V to 3.6 V V _{CC} = 4.5 V to 5.5 V		100 20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must be held HIGH or LOW. They may not float.

Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

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DC ELECTRICAL CHARACTERISTICS

						T _A = 25°C	;	$T_A = -40^{\circ}$	C to +85°C						
Symbol	Parameter	V _{CC} (V)	Con	ditions	Min	Тур	Max	Min	Max	Unit					
V _{IH}	HIGH Level Input	2.0			1.50	-	_	1.50	-	V					
	Voltage	3.0–5.5			0.7 x V _{CC}	-	-	0.7 x V _{CC}	-	1					
V _{IL}	LOW Level Input	2.0			-	-	0.50	-	0.50	٧					
	Voltage	3.0–5.5			-	-	0.3 x V _{CC}	-	0.3 x V _{CC}]					
V _{OH}	HIGH Level Output	2.0	$V_{IN} = V_{IH}$	I _{OH} = -50 μA	1.9	2.0	-	1.9	-	V					
	Voltage	3.0	or V _{IL}		2.9	3.0	-	2.9	-	1					
		4.5			4.4	4.5	-	4.4	-	1					
		3.0		I _{OH} = -4 mA	2.58	-	-	2.48	-	1					
		4.5		I _{OH} = -8 mA	3.94	-	-	3.80	-	1					
V _{OL}	LOW Level Output	2.0	$V_{IN} = V_{IH}$	I _{OL} = 50 μA	-	0.0	0.1	-	0.1	V					
	Voltage	3.0	or V _{IL}		-	0.0	0.1	-	0.1	1					
		4.5]]						-	0.0	0.1	-	0.1
		3.0		I _{OL} = 4 mA	-	-	0.36	-	0.44	1					
		4.5		I _{OL} = 8 mA	-	-	0.36	-	0.44	1					
l _{OZ}	3-STATE Output Off-State Current	5.5	V _{IN} = V _{IH} o V _{OUT} = V _C	or V _{IL} , _C or GND	-	-	±0.25	-	±2.5	μΑ					
I _{IN}	Input Leakage Current	0–5.5	V _{IN} = 5.5 V	or GND	-	-	±0.1	_	±1.0	μΑ					
I _{CC}	Quiescent Supply Current	5.5	V _{IN} = V _{CC} (or GND	-	-	4.0	-	40.0	μΑ					

NOISE CHARACTERISTICS

			T _A =			
Symbol	Parameter	V _{CC} (V)	Conditions	Тур	Max	Unit
V _{OLP}	Quiet Output Maximum Dynamic V _{OL} (Note 4)	5.0	C _L = 50 pF	0.5	0.8	V
V _{OLV}	Quiet Output Minimum Dynamic V _{OL} (Note 4)	5.0	C _L = 50 pF	-0.5	-0.8	V
V_{IHD}	Minimum HIGH Level Dynamic Input Voltage (Note 4)	5.0	C _L = 50 pF	-	3.5	V
V_{ILD}	Maximum LOW Level Dynamic Input Voltage (Note 4)	5.0	C _L = 50 pF	-	1.5	V

^{4.} Parameter guaranteed by design.

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AC ELECTRICAL CHARACTERISTICS

						T _A = 25°C		$T_A = -40^{\circ}$	C to +85°C	
Symbol	Parameter	V _{CC} (V)	Con	ditions	Min	Тур	Max	Min	Max	Unit
t _{PLH} ,	Propagation Delay	3.3 ±0.3		C _L = 15 pF	-	5.6	8.0	1.0	9.5	ns
t _{PHL}	Time			C _L = 50 pF	-	8.1	11.5	1.0	13.0	
		5.0 ±0.5		C _L = 15 pF	-	3.8	5.5	1.0	6.5	ns
				C _L = 50 pF	-	5.3	7.5	1.0	8.5	
t _{PZL} ,	3-STATE Output	3.3 ±0.3	$R_L = 1 \text{ k}\Omega$	C _L = 15 pF	-	5.4	8.0	1.0	9.5	ns
t _{PZH}	Enable Time			C _L = 50 pF	-	7.9	11.5	1.0	13.0	
		5.0 ±0.5		C _L = 15 pF	-	3.6	5.1	1.0	6.0	ns
				C _L = 50 pF	-	5.1	7.1	1.0	8.0	
t _{PLZ} ,	3-STATE Output	3.3 ±0.3	$R_L = 1 \text{ k}\Omega$	C _L = 50 pF	-	9.5	13.2	1.0	15.0	ns
t _{PHZ}	Disable Time	5.0 ±0.5		C _L = 50 pF	-	6.1	8.8	1.0	10.0	
t _{OSLH} ,	Output to Output	3.3 ±0.3	(Note 6)	C _L = 50 pF	-	-	1.5	-	1.5	ns
^t OSHL	Skew	5.0 ±0.5		C _L = 50 pF	-	-	1.0	-	1.0	
C _{IN}	Input Capacitance		V _{CC} = Oper	n	-	4	10	-	10	pF
C _{OUT}	Output Capacitance		V _{CC} = 5.0 \	/	-	6	-	_	-	pF
C _{PD}	Power Dissipation Capacitance		(Note 6)		-	14	-	-	-	pF

ORDERING INFORMATION

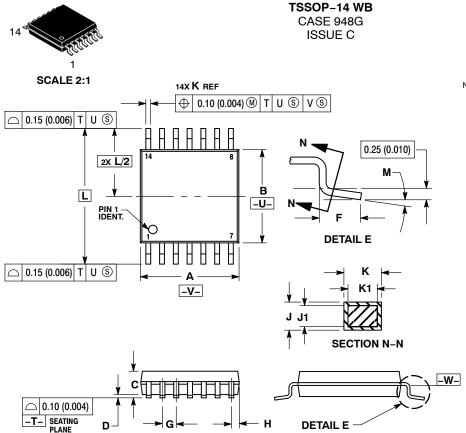
Device Order Number	Top Marking	Package Type	Shipping [†]
74VHC125MTCX	VHC 125	TSSOP-14 WB (Pb-Free, Halide Free)	2,500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Parameter guaranteed by design. t_{OSLH} = |t_{PLHmax} - t_{PLHmin}|; t_{OSHL} = |t_{PHLmax} - t_{PHLmin}|.
 C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC} (Opr.) = C_{PD} × V_{CC} × f_{IN} + I_{CC} / 4 (per bit).

DATE 17 FEB 2016





- NOTES.

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSION A DOES NOT INCLUDE MOLD
- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 DIMENSION B DOES NOT INCLUDE
- INTERLEAD FLASH OR PROTRUSION.
 INTERLEAD FLASH OR PROTRUSION SHALL
- INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

 TERMINAL NUMBERS ARE SHOWN FOR DEEEDENIC OMITY.
- REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.90	5.10	0.193	0.200	
В	4.30	4.50	0.169	0.177	
С		1.20		0.047	
D	0.05	0.15	0.002	0.006	
F	0.50	0.75	0.020	0.030	
G	0.65	BSC	0.026 BSC		
Н	0.50	0.60	0.020	0.024	
J	0.09	0.20	0.004	0.008	
J1	0.09	0.16	0.004	0.006	
K	0.19	0.30	0.007	0.012	
K1	0.19	0.25	0.007	0.010	
L	6.40	BSC	0.252	BSC	
м	o °	8 °	o °	a °	

GENERIC MARKING DIAGRAM*



= Assembly Location

= Wafer Lot = Year = Work Week W

= Pb-Free Package (Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "∎", may or may not be present. Some products may

TERS

not follow the Generic Marking.

	□ 0.65 □ PITCH
, <u> </u>	
14X A 14X	-
0.36 14X 1.26	DIMENSIONS: MILLIMETERS
*For additional information on ou	r Pb-Free strategy and soldering

RECOMMENDED SOLDERING FOOTPRINT*

- 7.06 -

details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98ASH70246A	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED"	
DESCRIPTION:	TSSOP-14 WB		PAGE 1 OF 1

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